



## Material Content Data Sheet



<b>Sales Product Name</b>		IPN80R4K5P7		<b>Issued</b>		22. January 2018		
<b>MA#</b>		MA002116572						
<b>Package</b>		PG-SOT223-3-1		<b>Weight*</b>		115.78 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	0.679	0.59	0.59	5863	5863
leadframe	inorganic material	phosphorus	7723-14-0	0.016	0.01		136	
	non noble metal	iron	7439-89-6	0.052	0.05		452	
	non noble metal	copper	7440-50-8	52.304	45.18	45.24	451771	452359
	non noble metal	copper	7440-50-8	0.105	0.09	0.09	908	908
wire	non noble metal	copper	7440-50-8	0.105	0.09	0.09	908	908
encapsulation	organic material	carbon black	1333-86-4	0.180	0.16		1552	
	plastics	epoxy resin	-	7.009	6.05		60536	
	inorganic material	silicondioxide	60676-86-0	52.714	45.53	51.74	455312	517400
leadfinish	non noble metal	tin	7440-31-5	1.352	1.17	1.17	11679	11679
plating	noble metal	silver	7440-22-4	0.220	0.19	0.19	1905	1905
solder	non noble metal	tin	7440-31-5	0.023	0.02		198	
	noble metal	silver	7440-22-4	0.029	0.02		247	
	non noble metal	lead	7439-92-1	1.093	0.94	0.98	9441	9886
*deviation	< 10%				Sum in total:	100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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